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November 2015

FOD852 4-Pin DIP Photodarlington Output Optocoupler

Features

- High Current Transfer Ratio: 1000% Minimum
- Safety and Regulatory Approvals
 - UL1577, 5,000 VAC_{RMS} for 1 Minute
 - DIN EN/IEC60747-5-5

Applications

- Power Supply Regulators
- Digital Logic Inputs
- Microprocessor Inputs

Description

The FOD852 consists of gallium arsenide infrared emitting diode driving a silicon photodarlington output (with integral base-emitter resistor) in a 4-pin dual in-line package.

Functional Block Diagram

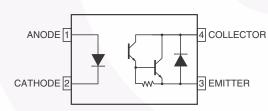


Figure 1. Schematic



Figure 2. Package Outlines

Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter		Characteristics
Installation Classifications per DIN VDE	< 150 V _{RMS}	I–IV
0110/1.89 Table 1, For Rated Mains Voltage	< 300 V _{RMS}	I–III
Climatic Classification		30/110/21
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit	
V	Input-to-Output Test Voltage, Method A, $V_{IORM} \times 1.6 = V_{PR}$, Type and Sample Test with $t_m = 10$ s, Partial Discharge < 5 pC	1360	V _{peak}	
V _{PR}	Input-to-Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC	1560	V _{peak}	
V _{IORM}	Maximum Working Insulation Voltage	850	V _{peak}	
V _{IOTM}	Highest Allowable Over-Voltage	6000	V _{peak}	
	External Creepage	≥7	mm	
	External Clearance	≥ 7	mm	
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.4	mm	
Τ _S	Case Temperature ⁽¹⁾	175	°C	
I _{S,INPUT}	Input Current ⁽¹⁾	400	mA	
P _{S,OUTPUT}	Output Power ⁽¹⁾	700	mW	
R _{IO}	Insulation Resistance at T _S , $V_{IO} = 500 V^{(1)}$	> 10 ¹¹	Ω	

Note:

1. Safety limit values - maximum values allowed in the event of a failure.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A = 25^{\circ}C$ Unless otherwise specified.

Symbol	Parameter	Value	Units
Total Device			
T _{STG}	Storage Temperature	-55 to +125	°C
T _{OPR}	Operating Temperature	-30 to +100	°C
TJ	Junction Temperature	-55 to +100	°C
T _{SOL}	Lead Solder Temperature	260 for 10 seconds	°C
P _{TOT}	Total Device Power Dissipation	200	mW
Input			
١ _F	Continuous Forward Current	50	mA
V _R	Reverse Voltage	6	V
PD	LED Power Dissipation	70	mW
Output	·		
V _{CEO}	Collector-Emitter Voltage	300	V
V _{ECO}	Emitter-Collector Voltage	0.1	V
Ι _C	Continuous Collector Current	150	mA
P _C	Collector Power Dissipation	150	mW

Electrical Characteristics

 $T_A = 25^{\circ}C$ unless otherwise specified.

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Input	•					
V _F	Forward Voltage	I _F = 10 mA		1.2	1.4	V
I _R	Reverse Current	$V_R = 4 V$			10	μA
Ct	Terminal Capacitance	V = 0, f = 1 kHz		30	250	pF
Output			·			
I _{CEO}	Collector Dark Current	$V_{CE} = 200 \text{ V}, I_F = 0$			200	nA
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_{\rm C} = 0.1 {\rm mA}, I_{\rm F} = 0$	300			V
BV _{ECO}	Emitter-Collector Breakdown Voltage	e I _E = 10 μA, I _F = 0	0.1			V

Transfer Characteristics

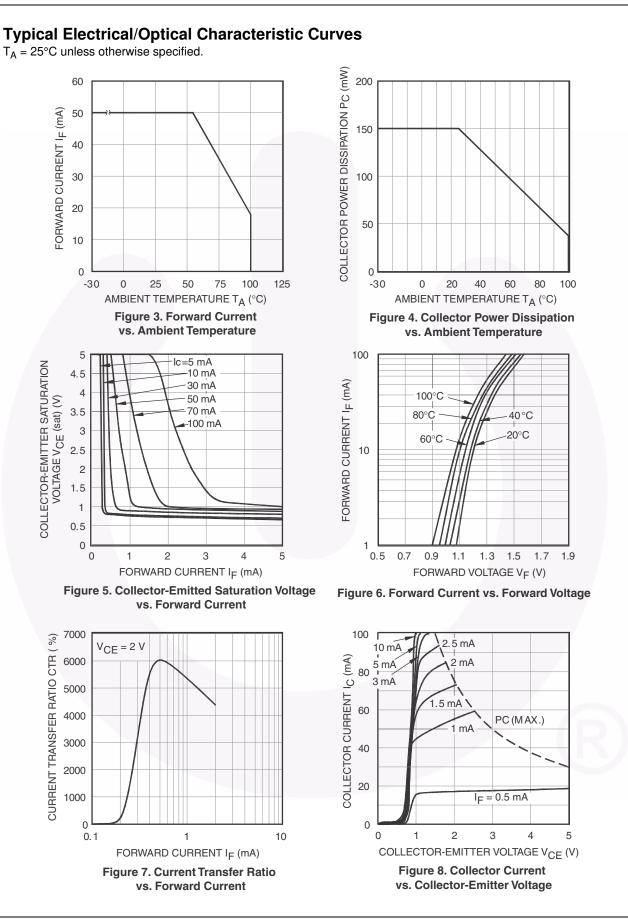
Symbol	DC Characteristic	Test Conditions	Min.	Тур.	Max.	Unit
۱ _C	Collector Current	I _F = 1 mA, V _{CE} = 2 V	10	40	150	mA
CTR	Current Transfer Ratio ⁽²⁾	$V_{F} = 1 \text{ IIIA}, V_{CE} = 2 \text{ V}$	1,000	4,000	15,000	%
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	I _F = 20 mA, I _C = 100 mA			1.2	V
f _C	Cut-Off Frequency	V_{CE} = 2 V, I_{C} = 20 mA, R_{L} = 100 Ω , -3 dB	1	7		kHz
t _R	Response Time (Rise)	$V_{CE} = 2 \text{ V}, \text{ I}_{C} = 20 \text{ mA}, \text{ R}_{L} = 100 \Omega$		100	300	μs
t _F	Response Time (Fall)	$V_{CE} = 2$ V, $V_{C} = 20$ MA, $\Pi_{L} = 100.32$		20	100	μs

Isolation Characteristics

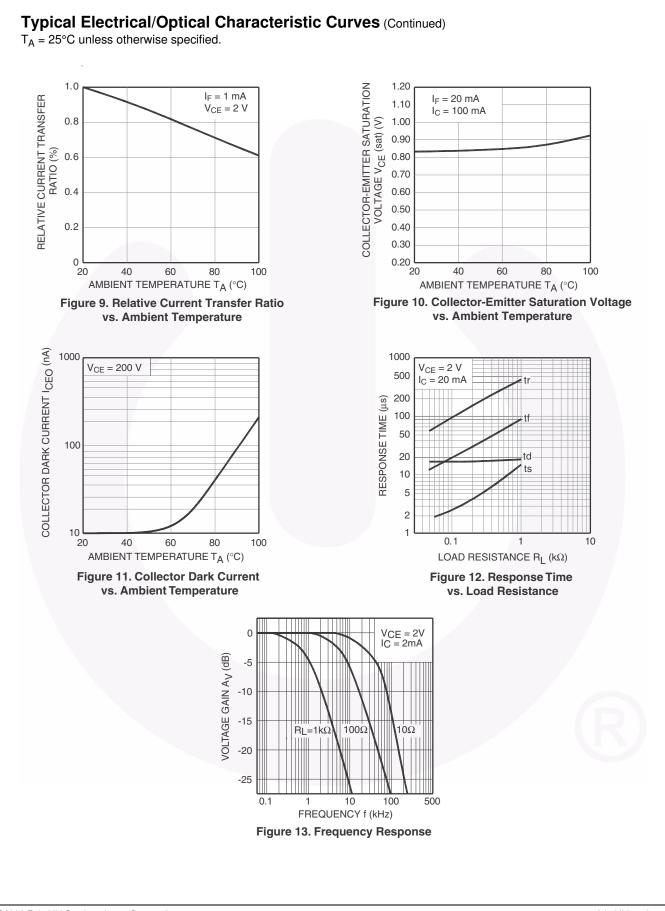
Symbol	Characteristic	Test Conditions	Min.	Тур.	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	f = 60 Hz, t = 1 minute, $I_{I-O} \le 2 \ \mu A$	5000			VAC _{RMS}
R _{ISO}	Isolation Resistance	$V_{I-O} = 500 V_{DC}$		10 ¹²		Ω
C _{ISO}	Isolation Capacitance	$V_{I-O} = 0, f = 1 MHz$		0.6	1.0	pf

Note:

2. Current Transfer Ratio (CTR) = $I_C / I_F x 100\%$.



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FOD852 — 4-Pin DIP Photodarlington Output Optocoupler

Test Circuits

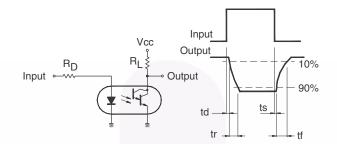


Figure 14. Test Circuit for Response Time

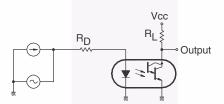
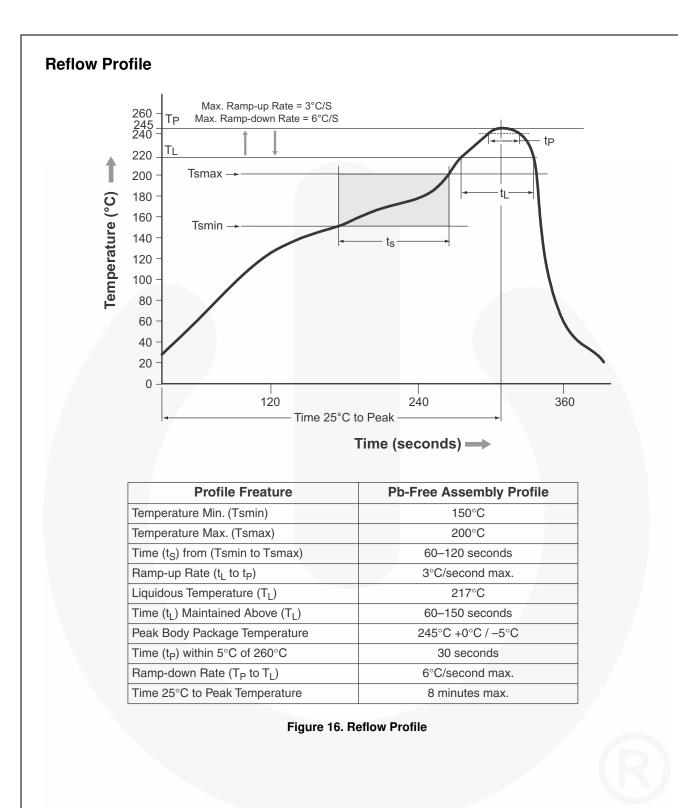


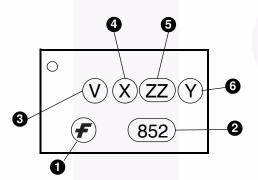
Figure 15. Test Circuit for Frequency Response



Ordering Information

Part Number	Package	Packing Method
FOD852	DIP 4-Pin	Tube (100 units per tube)
FOD852S	SMT 4-Pin (Lead Bend)	Tube (100 units per tube)
FOD852SD	SMT 4-Pin (Lead Bend)	Tape and Reel (1,000 units per reel)
FOD852300	DIP 4-Pin, DIN EN/IEC60747-5-5 option	Tube (100 units per tube)
FOD8523S	SMT 4-Pin (Lead Bend), DIN EN/IEC60747-5-5 option	Tube (100 units per tube)
FOD8523SD	SMT 4-Pin (Lead Bend), DIN EN/IEC60747-5-5 option	Tape and Reel (1,000 units per reel)
FOD852300W	DIP 4-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 option	Tube (100 units per tube)

Marking Information



Definit	tions		
1	Fairchild Logo		
2	Device Number		
3	DIN EN/IEC60747-5-5 Option (only appears on parts ordered with this option)		
4	One-Digit Year Code, e.g., '5'		
5	Two-Digit Work Week, Ranging from '01' to '53'		
6	Assembly Package Code Y = Manufactured in Thailand YA = Manufactured in China		

FOD852 — 4-Pin DIP Photodarlington Output Optocoupler

Carrier Tape Specifications

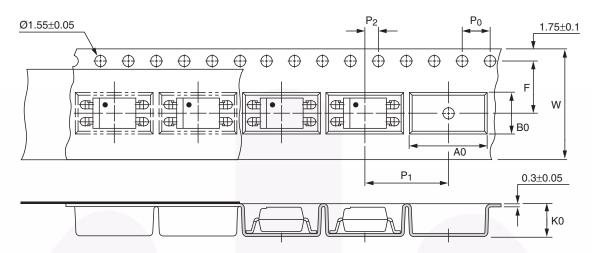
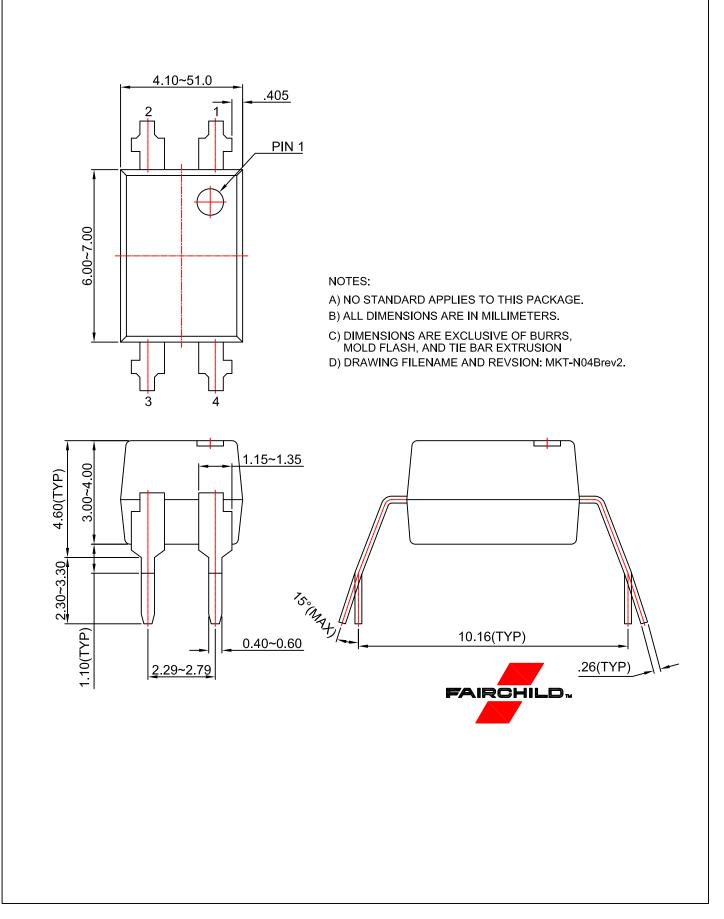
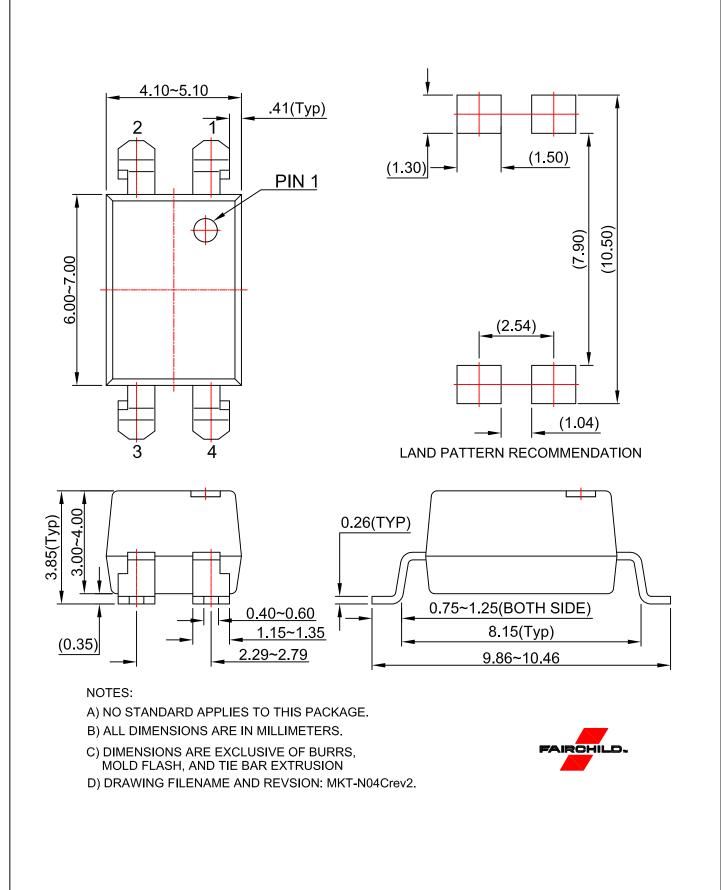
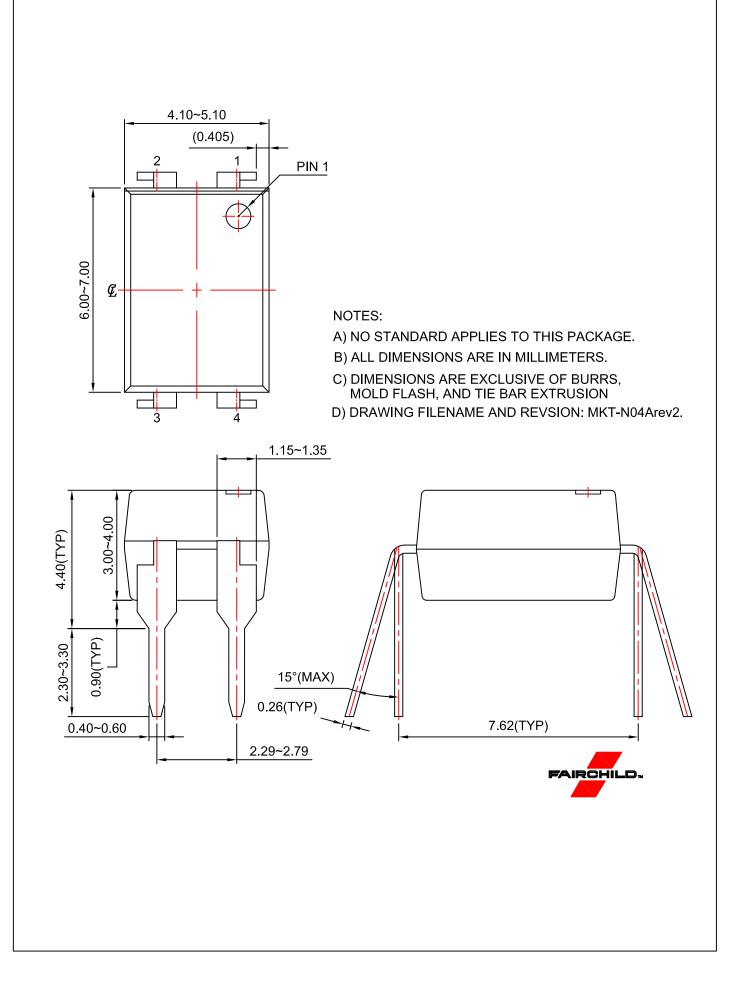


Figure 17. Carrier Tape Specification

Symbol	Description	Dimensions in mm (inches)
W	Tape wide	16 ± 0.3 (0.63)
P ₀	Pitch of sprocket holes	4 ± 0.1 (0.15)
F P ₂	Distance of compartment	7.5 ± 0.1 (0.295) 2 ± 0.1 (0.079)
P ₁	Distance of compartment to compartment	12 ± 0.1 (0.472)
A0	Compartment	10.45 ± 0.1 (0.411)
B0		5.30 ± 0.1 (0.209)
K0		4.25 ± 0.1 (0.167)







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